Pro**Labs**

TTD4580-46-PI-C

Arris[®] TTD458046PI Compatible TAA 10GBase-DWDM SFP+ Transceiver (SMF, 1540.56nm, 80km, LC, DOM, -40 to 95C)

Features:

- SFF-8431 and SFF-8432 Compliance
- Cooled DWDM EML transmitter with TEC
- Supports 9.95Gb/s to 11.3Gb/s bit rates
- APD Receiver
- LC/UPC Duplex optical connector interface
- Power Consumption < 2.8W, depending on temperature
- Single 3.3V power supply
- Hot-pluggable SFP+ footprint
- Operating Temperature: -40C to +95C
- RoHS-6 Complaint



Applications:

- 10x Gigabit Ethernet over DWDM
- 8x/10x Fibre Channel
- Access, Metro and Enterprise

Product Description

This Arris[®] TTD458046PI compatible SFP+ transceiver provides 10GBase-DWDM throughput up to 80km over single-mode fiber (SMF) using a wavelength of 1540.56nm via an LC connector. It is guaranteed to be 100% compatible with the equivalent Arris[®] transceiver. This easy to install, hot swappable transceiver has been programmed, uniquely serialized and data-traffic and application tested to ensure that it will initialize and perform identically. Digital optical monitoring (DOM) support is also present to allow access to real-time operating parameters. This transceiver is Trade Agreements Act (TAA) compliant. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

ProLabs's transceivers are RoHS compliant and lead-free.

TAA refers to the Trade Agreements Act (19 U.S.C. & 2501-2581), which is intended to foster fair and open international trade. TAA requires that the U.S. Government may acquire only "U.S. – made or designated country end products."



Rev. 111921

Regulatory Compliance

- ESD to the Electrical PINs: compatible with MIL-STD-883E Method 3015.4
- ESD to the LC Receptacle: compatible with IEC 61000-4-3
- EMI/EMC compatible with FCC Part 15 Subpart B Rules, EN55022:2010
- Laser Eye Safety compatible with FDA 21CFR, EN60950-1& EN (IEC) 60825-1,2
- RoHS compliant with EU RoHS 2.0 directive 2015/863/EU

ITU-T Grid Channel (100GHz Spacing)

Channel	THz	nm	Channel	THz	nm
17*	191.7	1563.86	40	194	1545.32
18	191.8	1563.05	41	194.1	1544.53
19	191.9	1562.23	42	194.2	1543.73
20	192.0	1561.42	43	194.3	1542.94
21	192.1	1560.61	44	194.4	1542.14
22	192.2	1559.79	45	194.5	1541.35
23	192.3	1558.98	46	194.6	1540.56
24	192.4	1558.17	47	194.7	1539.77
25	192.5	1557.36	48	194.8	1538.98
26	192.6	1556.55	49	194.9	1538.19
27	192.7	1555.75	50	195.0	1537.40
28	192.8	1554.94	51	195.1	1536.61
29	192.9	1554.13	52	195.2	1535.82
30	193.0	1553.33	53	195.3	1535.04
31	193.1	1552.52	54	195.4	1534.25
32	193.2	1551.72	55	195.5	1533.47
33	193.3	1550.92	56	195.6	1532.68
34	193.4	1550.12	57	195.7	1531.90
35	193.5	1549.32	58	195.8	1531.12
36	193.6	1548.51	59	195.9	1530.33
37	193.7	1547.72	60	196.0	1529.55
38	193.8	1546.92	61*	196.1	1528.77
39	193.9	1546.12			

*This channel is supported with limited availability.

Absolute Maximum Ratings

Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes
Power Supply Voltage	VccT, VccR	-0.5		4.0	V	
Storage Temperature	TS	-40		95	°C	
Operating Case Temperature	Тс	-40		95	°C	1
Relative Humidity (non-condensation)	RH	0		85	%	
Data Rate			10.3125		Gbps	
Maximum Range				80	km	

Notes:

1. With Airflows

Electrical Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes
Module Supply Voltage	VccT, VccR	+3.135	3.3	+3.465	V	
Total Power Consumption	РС			2.8	W	With Airflows
Power Supply Noise Tolerance	PSNT			66	mVp-p	10 Hz to 10 MHz
Transmitter differential input voltage	Vp		2.5		V	
Low Speed Signal Electrical Chara	cteristics					
Tx_Fault, Rx_LOS	VOL	-0.3		0.4	V	At 0.7mA
	ЮН	-50		37.5	μΑ	1
Tx_Disable, RS0, RS1	VIL	-0.3		0.8	V	2
	VIH	2.0		VccT + 0.3	V	2

- 1. Measured with a $4.7 k\Omega$ load pull up to Vcc_Host
- 2. Tx Disable has an internal $4.7k\Omega$ to $10k\Omega$ pull up to VccT

Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes
Module Transmitter Input Electrical Specif	fications at B)				
Tx Input Differential Voltage	VI	190		700	mV	1
Differential Input Resistance	RI	95	100	105	ohm	
Differential Input S-parameter	60044			Note 3	dB	0.01to 4.1 GHz
(Note 2)	SDD11			Note 4	dB	4.1 to 11.1 GHz
Reflected Differential to Common Mode Conversion	SCD11			-10	dB	0.01 to 11.1GHz
Module Receiver Output Electrical Specifie	cations at C'					
Rx Output Differential Voltage	Vo	300		850	mV	1
Termination Mismatch at 1 MHz	ΔΖΜ			5	%	
Single Ended Output Voltage Tolerance		-0.3		4.0	V	
Output AC Common Mode Voltage				7.5	mV	RMS, 5
	(0022			Note 6	dB	0.01 to 4.1 GHz
Differential Output S-parameter	SDD22			Note 7	dB	4.1 to 11.1 GHz
Common Mode Output Reflection				Note 8	dB	0.01 to 2.5 GHz
Coefficient	SCC22			-3	dB	2.5 to 11.1 GHz
Rx Output Rise and Fall Time	tr, tf	28			ps	20% to 80%
Rx Output Total Jitter	TJ			0.70	Ulp-p	
Rx Output Deterministic Jitter	DJ			0.42	Ulp-p	

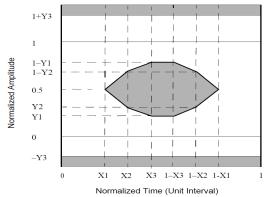
High Speed Signal Electrical Characteristics

- 1. Voltage swing for 1G operation is equivalent to voltage swing in 10G operation (SFF-8431 Rev 3.0).
- 2. Measured at B" with Host Compliance Board and Module Compliance Board pair.
- 3. Reflection Coefficient given by equation SDD11 (dB) $< -12 + 2 \times$ SQRT (f), with f in GHz.
- 4. Reflection Coefficient given by equation SDD11 (dB) < $-6.3 + 13 \times \log 10$ (f/5.5), with f in GHz.
- 5. The RMS value is measured by calculating the standard deviation of the histogram for one UI of the common mode signal.
- 6. Reflection Coefficient given by equation SDD22 (dB) < -12 + 2 × SQRT (f), with f in GHz.
- 7. Reflection Coefficient given by equation SDD22 (dB) < -6.3 + $13 \times \log 10$ (f/5.5), with f in GHz.
- 8. Reflection Coefficient given by equation SCC22 (dB) $< -7 + 1.6 \times f$, with f in GHz.

Optical Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes
Transmitter						
Peak Wavelength	λρ	ITU-T 694.1 G	irid Wavelength	ı	nm	
Center wavelength spacing		100			GHz	
Spectral Width@-20dB	Δλ-20dB			0.30	nm	At -20dB
Side Mode Suppression Ratio	SMSR	30.0			dB	
Average Optical Power	Pave	0		+5.0	dBm	
Extinction Ratio	ER	8.2			dB	@10.3Gb/s, PRBS 2 ³¹ -1
Transmitter and dispersion penalty	DP			3.5	dB	
Laser Off Power	Poff			-30.0	dBm	
Relative intensity noise	RIN120MA			-128.0	dB/Hz	
Wavelength Stability after Startup		λρ - 100		λp + 100	pm	
Transmitter Output Eye Mask		IEEE 80		3		
Receiver						
Operating Wavelength	λο	1260		1600	nm	
Receiver sensitivity (Average)	S			-23.0	dBm	1
Receiver Power (Pave) Overload	OL	-6.0			dBm	1
Sensitivity (OMA)	SOMA			-21.9	dBm	1
Receiver Reflectance	RR			-27.0	dB	@ λ ₀
Loss of signal-Asserted	LOSA	-37.0			dBm	2
Loss of signal-De-asserted	LOSD			-24.0	dBm	2
Loss of signal Hysteresis	LOSD-A	0.5	2.5	5.0	dB	

- 1. Measured with at 10.3125Gb/s, Source ER>8.2dB, PRBS 231-1, BER<1x10-12
- 2. Loss of Signal (LOS) detection responds only to OMA and the indicator will respond unpredictably with the application of un-modulated optical.
- 3. Transmitter Optical Eye Mask Definition



- a) SFP+ module compliance points are defined as the following, SFF8431/Chapter3.3.2/Figure14:
 - B': SFP+ module transmitter input at the input of the Module Compliance Board.
 - C': SFP+ module receiver output at the output of the Module Compliance Board.

Low Speed Signals Timing Specifications

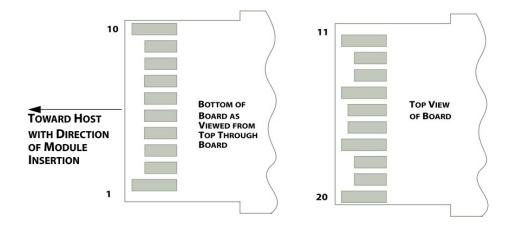
Parameter	Symbol	Min.	Max.	Unit	Notes
Tx Disable assert time	t_off		100	μs	1
Tx Disable negate time	t_on		2	ms	2
Time to initialize. Cold and warm start time	t_start_up		90	S	3, Cooled type
Rx LOS assert delay	t_los_on		100	μs	4
Rx LOS negate delay	t_los_off		100	μs	5
Tx Fault Assert	Tx_fault_on		1	ms	6
Tx Fault Reset	t_reset	10		μs	7

- 1. Rising edge of Tx_Disable to fall of output signal below 10% of nominal
- 2. Falling edge of Tx_Disable to rise of output signal above 90% of nominal. This only applies in normal operation, not during start up or fault recovery
- 3. Time from power on or falling edge of Tx_Disable to when the modulated optical output rises above 90% of nominal and the Two-Wire interface is available
- 4. From occurrence of loss of signal to assertion of Rx_LOS
- 5. From occurrence of presence of signal to negation of Rx_LOS
- 6. From occurrence of fault to assertion of Tx_Fault
- 7. Time Tx_Disable must be held high to reset Tx_Fault

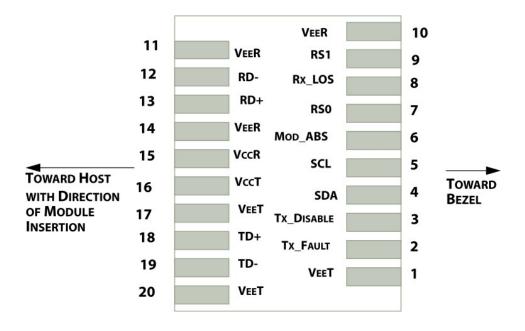
Pin Descriptions

Pin	Symbol	Descriptions	Sequence	Notes
1	VeeT	Transmitter Signal Ground	1 st	
2	Tx_Fault	Transmitter Fault (LVTTL-O) – High indicates a fault condition	3rd	1
3	Tx_Disable	Transmitter Disable (LVTTL-I) – High or open disables the transmitter	3rd	2
4	SDA	Two Wire Serial Interface Data Line (LVCMOS – I/O) (same as MOD-DEF2 in INF-8074)	3rd	3
5	SCL	Two Wire Serial Interface Clock Line (LVCMOS – I/O) (same as MOD-DEF1 in INF-8074)	3rd	3
6	MOD-ABS	Module Absent, (controlled by module)	3rd	4
7	RSO	Receiver Rate Select 0 - not used (Internally pull-down, 51kohm)	3rd	
8	RX_LOS	Receiver Loss of Signal Indication (LVTTL-O)	3rd	1
9	RS1	Transmitter Rate Select 1 - not used (Internally pull-down, 51kohm)	3rd	
10	VeeR	Receiver Signal Ground	1 st	
11	VeeR	Receiver Signal Ground	1 st	
12	RD-	Receiver Data Output, Inverted (CML-O)	3rd	
13	RD+	Receiver Data Output, Non-Inverted (CML-O)	3rd	
14	VeeR	Receiver Signal Ground	1 st	
15	VccR	Receiver Power + 3.3 V	2 nd	
16	VccT	Transmitter Power + 3.3 V	2 nd	
17	VeeT	Transmitter Signal Ground	1 st	
18	TD+	Transmitter Data Input, Non-Inverted Data (CML-I)	3rd	
19	TD-	Transmitter Data Input, Inverted (CML-I)	3rd	
20	VeeT	Transmitter Signal Ground	1 st	

- 1. This is an open drain output that on the host board requires a $4.7k\Omega$ to $10k\Omega$ pull-up resistor to Vcc_Host.
- 2. This input is internally biased high with a $4.7k\Omega$ to $10k\Omega$ pull-up resistor to VccT.
- 3. Two-Wire Serial interface clock and data lines require an external pull-up resistor dependent on the capacitance load.
- 4. They must be pulled up with a $4.7k\Omega$ to $10 k\Omega$ resistor on the host board. MOD-ABS is grounded by the module to indicate the module is present.

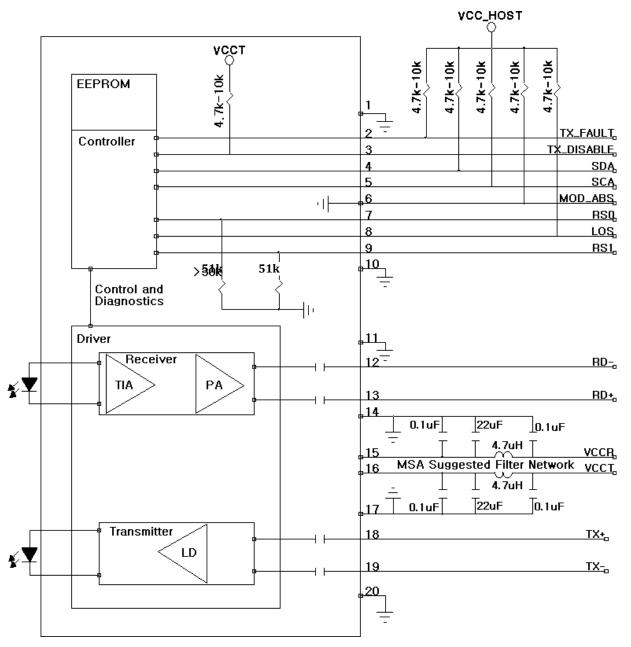


SFP+ Transceiver Electrical Pad Layout



20-pin Host PCB SFP+ pad assignment top view

Recommended Application Schematic



- 1. Tx_Disable: Transmitter Disable, logic high, open drain compatible, 4.7k to 10kohm pull up to Vcc on module.
- 2. Tx_Fault: Transmitter Fault, logic high, open drain compatible, 4.7k to 10kohm pull up to Vcc on Host.
- 3. Rx_LOS: Receiver Loss of Signal, logic high, open drain compatible, 4.7k to 10kohm pull up to Vcc on Host.

2-Wire Interface Electrical Specifications

Parameter	Symbol	Min.	Max.	Unit	Notes
Host 2-Wire Vcc	Vcch	3.14	3.46	V	1
SCL and SDA	VOL	0.0	0.8	V	Rp pulled to VccT/R, 2
	VOH	Vcch-0.5	Vcch+0.3	V	
SCL and SDA	VIL	-0.3	VccT*0.3	V	3
	VIH	VccT*0.7	VccT+0.5	V	
Input Current on the SCL and SDA Contacts	11	-10	10	μA	
Capacitance on SCL and SDA contacts	Ci		14	pF	4
Total bus capacitance for SCL and SDA	Cb ^[5]		100	pF	At 400kHz, 3.0kΩ Rp, max At 100kHz, 8.0kΩ Rp, max
			290	pF	At 400kHz, 1.1kΩ Rp, max At 100kHz, 2.75kΩ Rp, max

- 1. The Host 2-wire Vcc is the voltage used for resistive pull ups for the 2 wire interface
- 2. Rp is the pull up resistor. Active bus termination may be used by the host in place of a pull up resistor. Pull ups can be connected to any one of several power supplies, however the host board design shall ensure that no module contact has voltage exceeding module VccT/R + 0.5 V nor requires the module to sink more than 3.0mA current.
- 3. These voltages are measured on the other side of the connector to the device under test.
- 4. Ci is the capacitance looking into the module SCL and SDA contacts.0
- 5. Cb is the total bus capacitance on the SCL or SDA bus.

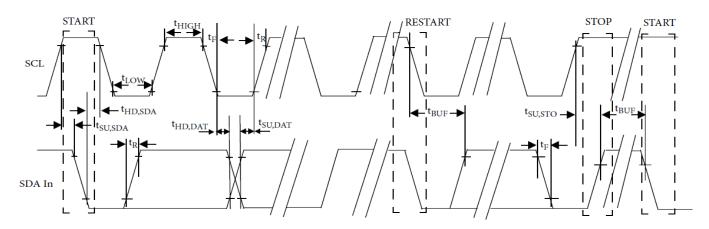
2-Wire Timing Specifications

Parameter	Symbol	Min.	Max.	Unit	Notes
Clock Frequency	fSCL	0	400	kHz	1
Clock Pulse Width Low	tLOW	1.3		μs	
Clock Pulse Width High	thigh	0.6		μs	
Stop to Start Time	tBUF	20		μs	2
Start Hold Time	thd,sta	0.6		μs	
Start Set-up Time	tSU,STA	0.6		μs	
Data In Hold Time	thd,dat	0		μs	
Data In Set-up Time	tSU,DAT	0.1		μs	
Input Rise Time (100kHz)	tR,100		1000	ns	3
Input Rise Time (400kHz)	tR,400		300	ns	3
Input Fall Time (100kHz)	tF,100		300	ns	4
Input Fall Time (400kHz)	tF,400		300	ns	4
Stop Set-up Time	tsu,sto	0.6		μs	
Serial Interface Clock Holdoff "Clock Stretching"	t_clock_hold		500	μs	5

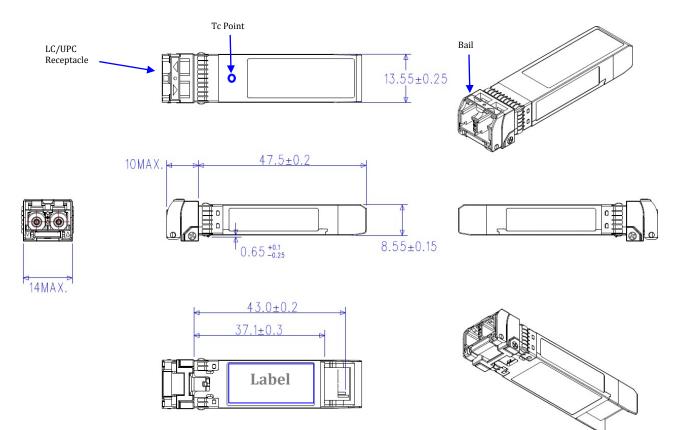
Notes:

- 1. Module shall operate with f_{SCL} up to 100 kHz without requiring clock stretching. The module may clock stretch with f_{SCL} greater than 100 kHz and up to 400 kHz.
- 2. Between STOP and START and between ACK and Re-START.
- 3. From (V_{IL},MAX 0.15) to (VIH,MIN + 0.15)
- 4. From (V_{IH} ,MIN + 0.15) to (VIL,MAX 0.15)
- 5. Maximum time the module may hold the SCL line low before continuing with a read or write operation.

2-Wire Bus Timing Diagram



Mechanical Specifications



About ProLabs

Our experience comes as standard; for over 15 years ProLabs has delivered optical connectivity solutions that give our customers freedom and choice through our ability to provide seamless interoperability. At the heart of our company is the ability to provide state-of-the-art optical transport and connectivity solutions that are compatible with over 90 optical switching and transport platforms.

Complete Portfolio of Network Solutions

ProLabs is focused on innovations in optical transport and connectivity. The combination of our knowledge of optics and networking equipment enables ProLabs to be your single source for optical transport and connectivity solutions from 100Mb to 400G while providing innovative solutions that increase network efficiency. We provide the optical connectivity expertise that is compatible with and enhances your switching and transport equipment.

Trusted Partner

Customer service is our number one value. ProLabs has invested in people, labs and manufacturing capacity to ensure that you get immediate answers to your questions and compatible product when needed. With Engineering and Manufacturing offices in the U.K. and U.S. augmented by field offices throughout the U.S., U.K. and Asia, ProLabs is able to be our customers best advocate 24 hours a day.

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